# One Watt Amplifier Transistor

### **NPN Silicon**

#### **Features**

• Pb-Free Package is Available\*

#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Collector - Emitter Voltage	V <sub>CEO</sub>	100	Vdc
Collector - Base Voltage	V <sub>CBO</sub>	100	Vdc
Emitter – Base Voltage	V <sub>EBO</sub>	5.0	Vdc
Collector Current – Continuous	Ic	0.5	Adc
Total Device Dissipation @ T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub>	1.0 8.0	W mW/°C
Total Device Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	P <sub>D</sub>	2.5 20	W mW/°C
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

#### THERMAL CHARACTERISTICS

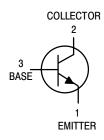
Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	125	°C/W
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	50	°C/W

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.



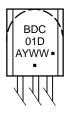
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#### **MARKING DIAGRAM**



BDC01D = Device Code A = Assembly Location

Y = Year
WW = Work Week
Pb-Free Package
(Note: Microdot may be in either location)

#### **ORDERING INFORMATION**

Device	Package	Shipping
BDC01DRL1	TO-92	2000 / Tape & Reel
BDC01DRL1G	TO-92 (Pb-Free)	5000 / Tape & Reel

<sup>\*</sup>For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

### **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector – Emitter Voltage (I <sub>C</sub> = 10 mA, I <sub>B</sub> = 0)	V <sub>(BR)CEO</sub>	100	-	Vdc
Collector Cutoff Current (V <sub>CB</sub> = 100 V, I <sub>E</sub> = 0)	Ісво	-	0.1	μAdc
Emitter Cutoff Current (I <sub>C</sub> = 0, V <sub>EB</sub> = 5.0 V)	ГЕВО	-	100	nAdc
ON CHARACTERISTICS	·			
DC Current Gain $(I_C = 100 \text{ mA}, V_{CE} = 1.0 \text{ V})$ $(I_C = 500 \text{ mA}, V_{CE} = 2.0 \text{ V})$	h <sub>FE</sub>	40 25	400 -	_
Collector – Emitter Saturation Voltage (Note 1) (I <sub>C</sub> = 1000 mA, I <sub>B</sub> = 100 mA)	V <sub>CE(sat)</sub>	-	0.7	Vdc
Collector – Emitter On Voltage (Note 1) (I <sub>C</sub> = 1000 mA, V <sub>CE</sub> = 1.0 V)	V <sub>BE(on)</sub>	-	1.2	Vdc
DYNAMIC CHARACTERISTICS	·			
Current Gain Bandwidth Product ( $I_C = 200 \text{ mA}, V_{CE} = 5.0 \text{ V}, f = 20 \text{ MHz}$ )	f⊤	50	-	MHz
Output Capacitance (V <sub>CB</sub> = 10 V, I <sub>E</sub> = 0, f = 1.0 MHz)	C <sub>ob</sub>	-	30	pF

<sup>1.</sup> Pulse Test: Pulse Width ≤ 300 μs; Duty Cycle 2.0%.

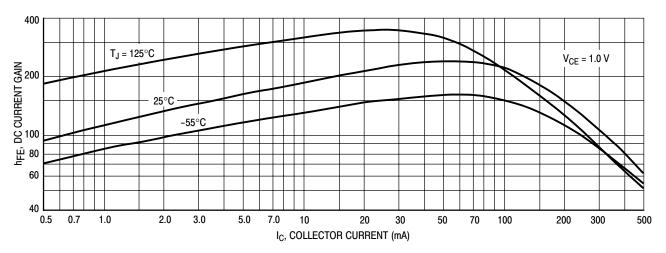


Figure 1. DC Current Gain

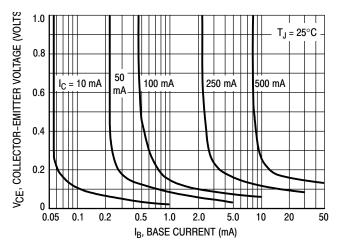


Figure 2. Collector Saturation Region

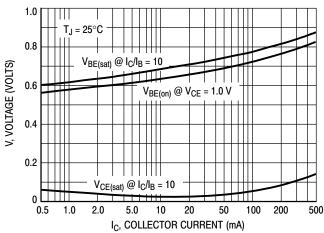


Figure 3. "On" Voltages

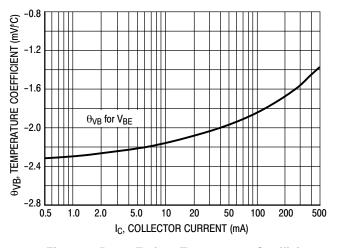


Figure 4. Base-Emitter Temperature Coefficient

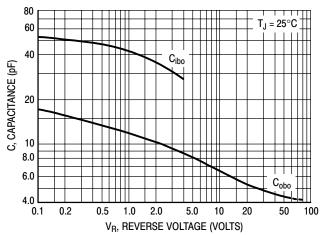


Figure 5. Capacitance

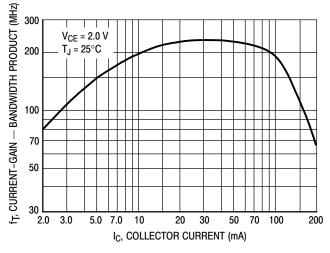


Figure 6. Current-Gain — Bandwidth Product

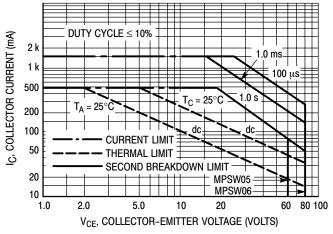
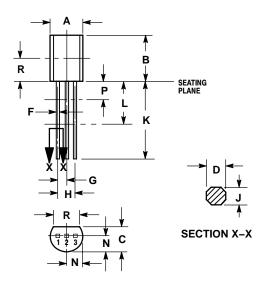


Figure 7. Active Region — Safe Operating Area

#### PACKAGE DIMENSIONS

TO-92 (TO-226) CASE 29-10 **ISSUE AL** 



#### NOTES

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
- 3. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
- DIMENSION F APPLIES BETWEEN P AND L.
  DIMENSIONS D AND J APPLY BETWEEN L AND K MIMIMUM. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INCHES MILLIMET		IETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.175	0.205	4.44	5.21
В	0.290	0.310	7.37	7.87
С	0.125	0.165	3.18	4.19
D	0.018	0.021	0.457	0.533
F	0.016	0.019	0.407	0.482
G	0.045	0.055	1.15	1.39
Н	0.095	0.105	2.42	2.66
J	0.018	0.024	0.46	0.61
K	0.500		12.70	
L	0.250		6.35	
N	0.080	0.105	2.04	2.66
P		0.100		2.54
R	0 135		3 43	

STYLE 14: PIN 1. EMITTER

COLLECTOR 2. 3.

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